MD1S THRU MD7S

MINIATURE GLASS PASSIVATED SINGLE-PHASE SURFACE MOUNT BRIDGE RECTIFIER

REVERSE VOLTAGE: FORWARD CURRENT:

50 to 1000 VOLTS 0.5 AMPERE

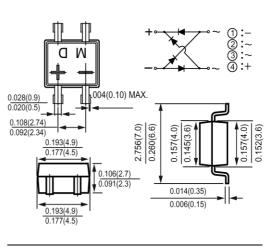
http://www.njzrg.com

FEATURES

- \cdot Glass passivated chip junction
- \cdot Low forward voltage drop
- \cdot High surge overload rating of 30 Amperes peak
- · Ideal for printed circuit board
- \cdot High temperature soldering guaranteed:
- 260°C for 10 seconds

MECHANICAL DATA

Case: Molded plastic, MD-S Epoxy: UL 94V-O rate flame retardant Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed Mounting position: Any Weight: 0.008ounce, 0.22gram



MD-S

Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified. Single phase, half wave, $60H_Z$, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	MD1S	MD2S	MD3S	MD4S	MD5S	MD6S	MD7S	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current								•	
(see Fig. 1) on glass-epoxy P.C.B (Note 2)	I _(AV) 0.5 0.8							Amp	
on aluminum substrate (Note 3)									
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM} 30						Amp		
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V	1.0							Volts
at 0.4A DC and 25	V _F								
Maximum Reverse Current at T _A =25	т	5.0 500							uAmp
at Rated DC Blocking Voltage T _A =125	I _R								
Typical Junction Capacitance (Note 1)	CJ				13				pF
Typical Thermal Resistance (Note 3)	R _{0JA}				70				/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$				20				/W
Operating and Storage Temperature Range	$T_{\rm J}$, Tstg				-55 to +15	0			

NOTES:

1- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.

2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads

3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad



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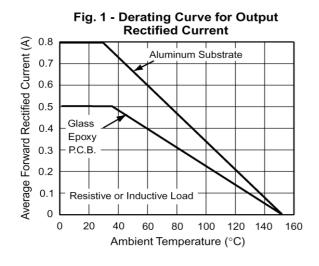
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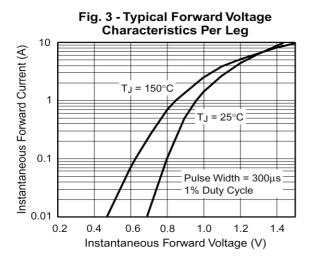
RATINGS AND CHARACTERISTIC CURVES

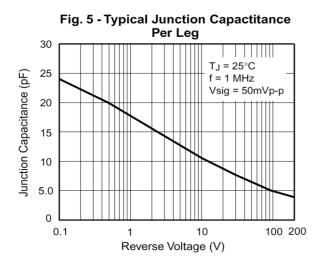
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GROWCHILD

ELECTRONICS







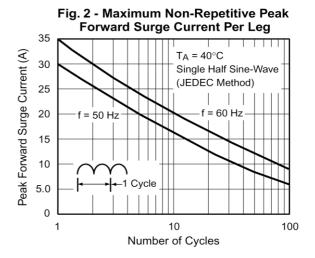


Fig. 4 - Typical Reverse Leakage **Characteristics Per Leg** 100 Instantaneous Reverse Leakage 10 TJ = 125°C Current (µA) 1 0.1 TJ = 25°C 0.01 20 60 0 40 80 100 Percent of Rated Peak Reverse Voltage (%)